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Bib Data Sheet

SERIAL NUMBER 10/685,312	FILING DATE 10/14/2003  RULE	CLASS 029	GROUP ART UNIT 3729	ATTORNEY DOCKET NO. 2269-5520.1US (02-0676.01)
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## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

This application is a DIV of 10/409,804 04/09/2003

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

none

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 01/16/2004

Foreign Priority claimed 35 USC 119 (a-d) conditions met Verified and Acknowledged	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance 	STATE OR COUNTRY ID	SHEETS DRAWING 4	TOTAL CLAIMS 14	INDEPENDENT CLAIMS 1
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## TITLE

Interposer substrates with multi-segment interconnect slots, semiconductor die packages including same, semiconductor dice for use therewith and methods of fabrication

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